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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	38
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	20K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 12x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	52-LQFP
Supplier Device Package	52-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100jjdfa-x0

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

Table 1-1. List of Ordering Part Numbers

(6/12)

Pin count	Package	Data flash	Fields of Application	Ordering Part Number
48 pins	48-pin plastic HWQFN (7 × 7 mm, 0.5 mm pitch)	Mounted	А	R5F100GAANA#U0, R5F100GCANA#U0, R5F100GDANA#U0, R5F100GEANA#U0, R5F100GFANA#U0, R5F100GGANA#U0, R5F100GHANA#U0, R5F100GJANA#U0, R5F100GKANA#U0,
				R5F100GLANA#U0
				R5F100GAANA#W0, R5F100GCANA#W0,
				R5F100GDANA#W0, R5F100GEANA#W0,
				R5F100GFANA#W0, R5F100GGANA#W0,
				R5F100GHANA#W0, R5F100GJANA#W0,
				R5F100GKANA#W0, R5F100GLANA#W0
			D	R5F100GADNA#U0, R5F100GCDNA#U0, R5F100GDDNA#U0,
				R5F100GEDNA#U0, R5F100GFDNA#U0, R5F100GGDNA#U0,
				R5F100GHDNA#U0, R5F100GJDNA#U0, R5F100GKDNA#U0,
				R5F100GLDNA#U0
				R5F100GADNA#W0, R5F100GCDNA#W0,
				R5F100GDDNA#W0, R5F100GEDNA#W0, R5F100GFDNA#W0, R5F100GGDNA#W0,
				R5F100GHDNA#W0, R5F100GJDNA#W0,
				R5F100GKDNA#W0, R5F100GLDNA#W0
			G	R5F100GAGNA#U0, R5F100GCGNA#U0, R5F100GDGNA#U0,
				R5F100GEGNA#U0, R5F100GFGNA#U0, R5F100GGGNA#U0,
				R5F100GHGNA#U0, R5F100GJGNA#U0
				R5F100GAGNA#W0, R5F100GCGNA#W0,
				R5F100GDGNA#W0, R5F100GEGNA#W0,
				R5F100GFGNA#W0, R5F100GGGNA#W0,
				R5F100GHGNA#W0, R5F100GJGNA#W0
		Not	Α	R5F101GAANA#U0, R5F101GCANA#U0, R5F101GDANA#U0,
		mounted		R5F101GEANA#U0, R5F101GFANA#U0, R5F101GGANA#U0,
				R5F101GHANA#U0, R5F101GJANA#U0, R5F101GKANA#U0,
				R5F101GLANA#U0
				R5F101GAANA#W0, R5F101GCANA#W0,
				R5F101GDANA#W0, R5F101GEANA#W0,
				R5F101GFANA#W0, R5F101GGANA#W0,
				R5F101GHANA#W0, R5F101GJANA#W0,
				R5F101GKANA#W0, R5F101GLANA#W0
			D	R5F101GADNA#U0, R5F101GCDNA#U0, R5F101GDDNA#U0,
				R5F101GEDNA#U0, R5F101GFDNA#U0, R5F101GGDNA#U0,
				R5F101GHDNA#U0, R5F101GJDNA#U0, R5F101GKDNA#U0,
				R5F101GLDNA#U0
				R5F101GADNA#W0, R5F101GCDNA#W0,
				R5F101GDDNA#W0, R5F101GEDNA#W0,
				R5F101GFDNA#W0, R5F101GGDNA#W0,
				R5F101GHDNA#W0, R5F101GJDNA#W0,
				R5F101GKDNA#W0, R5F101GLDNA#W0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.



Table 1-1. List of Ordering Part Numbers

(7/12)

Pin count	Package	Data flash	Fields of Application	Ordering Part Number
52 pins	52-pin plastic	Mounted	A	R5F100JCAFA#V0, R5F100JDAFA#V0, R5F100JEAFA#V0,
	LQFP (10 × 10			R5F100JFAFA#V0, R5F100JGAFA#V0, R5F100JHAFA#V0,
	mm, 0.65 mm			R5F100JJAFA#V0, R5F100JKAFA#V0, R5F100JLAFA#V0
	pitch)			R5F100JCAFA#X0, R5F100JDAFA#X0, R5F100JEAFA#X0,
				R5F100JFAFA#X0, R5F100JGAFA#X0, R5F100JHAFA#X0,
				R5F100JJAFA#X0, R5F100JKAFA#X0, R5F100JLAFA#X0
			D	R5F100JCDFA#V0, R5F100JDDFA#V0, R5F100JEDFA#V0,
				R5F100JFDFA#V0, R5F100JGDFA#V0, R5F100JHDFA#V0,
				R5F100JJDFA#V0, R5F100JKDFA#V0, R5F100JLDFA#V0
				R5F100JCDFA#X0, R5F100JDDFA#X0, R5F100JEDFA#X0,
				R5F100JFDFA#X0, R5F100JGDFA#X0, R5F100JHDFA#X0,
				R5F100JJDFA#X0, R5F100JKDFA#X0, R5F100JLDFA#X0
			G	R5F100JCGFA#V0, R5F100JDGFA#V0, R5F100JEGFA#V0,
				R5F100JFGFA#V0,R5F100JGGFA#V0, R5F100JHGFA#V0,
				R5F100JJGFA#V0
				R5F100JCGFA#X0, R5F100JDGFA#X0, R5F100JEGFA#X0,
				R5F100JFGFA#X0,R5F100JGGFA#X0, R5F100JHGFA#X0,
				R5F100JJGFA#X0
		Not	Α	R5F101JCAFA#V0, R5F101JDAFA#V0, R5F101JEAFA#V0,
		mounted		R5F101JFAFA#V0, R5F101JGAFA#V0, R5F101JHAFA#V0,
				R5F101JJAFA#V0, R5F101JKAFA#V0, R5F101JLAFA#V0
				R5F101JCAFA#X0, R5F101JDAFA#X0, R5F101JEAFA#X0,
				R5F101JFAFA#X0, R5F101JGAFA#X0, R5F101JHAFA#X0,
				R5F101JJAFA#X0, R5F101JKAFA#X0, R5F101JLAFA#X0
			D	R5F101JCDFA#V0, R5F101JDDFA#V0, R5F101JEDFA#V0,
				R5F101JFDFA#V0, R5F101JGDFA#V0, R5F101JHDFA#V0,
				R5F101JJDFA#V0, R5F101JKDFA#V0, R5F101JLDFA#V0
				R5F101JCDFA#X0, R5F101JDDFA#X0, R5F101JEDFA#X0,
				R5F101JFDFA#X0, R5F101JGDFA#X0, R5F101JHDFA#X0,
				R5F101JJDFA#X0, R5F101JKDFA#X0, R5F101JLDFA#X0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.

Table 1-1. List of Ordering Part Numbers

(8/12)

Pin count	Package	Data flash	Fields of	Ordering Part Number
			Application Note	
64 pins	64-pin plastic LQFP	Mounted	Α	R5F100LCAFA#V0, R5F100LDAFA#V0,
	(12 × 12 mm, 0.65			R5F100LEAFA#V0, R5F100LFAFA#V0,
	mm pitch)			R5F100LGAFA#V0, R5F100LHAFA#V0,
				R5F100LJAFA#V0, R5F100LKAFA#V0, R5F100LLAFA#V0
				R5F100LCAFA#X0, R5F100LDAFA#X0,
				R5F100LEAFA#X0, R5F100LFAFA#X0,
			D	R5F100LGAFA#X0, R5F100LHAFA#X0,
				R5F100LJAFA#X0, R5F100LKAFA#X0, R5F100LLAFA#X0
				R5F100LCDFA#V0, R5F100LDDFA#V0,
				R5F100LEDFA#V0, R5F100LFDFA#V0,
				R5F100LGDFA#V0, R5F100LHDFA#V0,
				R5F100LJDFA#V0, R5F100LKDFA#V0, R5F100LLDFA#V0
			G	R5F100LCDFA#X0, R5F100LDDFA#X0,
				R5F100LEDFA#X0, R5F100LFDFA#X0,
				R5F100LGDFA#X0, R5F100LHDFA#X0,
				R5F100LJDFA#X0, R5F100LKDFA#X0, R5F100LLDFA#X0
				R5F100LCGFA#V0, R5F100LDGFA#V0,
				R5F100LEGFA#V0, R5F100LFGFA#V0
				R5F100LCGFA#X0, R5F100LDGFA#X0,
				R5F100LEGFA#X0, R5F100LFGFA#X0
				R5F100LGGFA#V0, R5F100LHGFA#V0,
				R5F100LJGFA#V0
				R5F100LGGFA#X0, R5F100LHGFA#X0,
				R5F100LJGFA#X0
		Not	Α	R5F101LCAFA#V0, R5F101LDAFA#V0,
		mounted		R5F101LEAFA#V0, R5F101LFAFA#V0,
				R5F101LGAFA#V0, R5F101LHAFA#V0,
				R5F101LJAFA#V0, R5F101LKAFA#V0, R5F101LLAFA#V0
				R5F101LCAFA#X0, R5F101LDAFA#X0,
				R5F101LEAFA#X0, R5F101LFAFA#X0,
			D	R5F101LGAFA#X0, R5F101LHAFA#X0,
				R5F101LJAFA#X0, R5F101LKAFA#X0, R5F101LLAFA#X0
				R5F101LCDFA#V0, R5F101LDDFA#V0,
				R5F101LEDFA#V0, R5F101LFDFA#V0,
				R5F101LGDFA#V0, R5F101LHDFA#V0,
				R5F101LJDFA#V0, R5F101LKDFA#V0, R5F101LLDFA#V0
				R5F101LCDFA#X0, R5F101LDDFA#X0,
				R5F101LEDFA#X0, R5F101LFDFA#X0,
				R5F101LGDFA#X0, R5F101LHDFA#X0,
				R5F101LJDFA#X0, R5F101LKDFA#X0, R5F101LLDFA#X0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.



Table 1-1. List of Ordering Part Numbers

(9/12)

Pin count	Package	Data flash	Fields of Application	Ordering Part Number
64 pins	64-pin plastic LFQFP (10 × 10 mm, 0.5 mm pitch)	Mounted	A	R5F100LCAFB#V0, R5F100LDAFB#V0, R5F100LEAFB#V0, R5F100LFAFB#V0, R5F100LGAFB#V0, R5F100LHAFB#V0, R5F100LJAFB#V0, R5F100LKAFB#V0, R5F100LCAFB#X0, R5F100LDAFB#X0, R5F100LEAFB#X0, R5F100LFAFB#X0, R5F100LFAFB#X0, R5F100LJAFB#X0, R5F100LJAFB#X0, R5F100LJAFB#X0, R5F100LJAFB#X0, R5F100LJAFB#X0, R5F100LLAFB#X0
			D	R5F100LCDFB#V0, R5F100LDDFB#V0, R5F100LEDFB#V0, R5F100LFDFB#V0, R5F100LFDFB#V0, R5F100LHDFB#V0, R5F100LJDFB#V0, R5F100LJDFB#V0, R5F100LDFB#V0 R5F100LCDFB#X0, R5F100LDDFB#X0, R5F100LEDFB#X0, R5F100LFDFB#X0, R5F100LFDFB#X0, R5F100LJDFB#X0, R5F100LJDFB#X0, R5F100LJDFB#X0, R5F100LLDFB#X0
			G	R5F100LCGFB#V0, R5F100LDGFB#V0, R5F100LEGFB#V0, R5F100LFGFB#V0 R5F100LCGFB#X0, R5F100LDGFB#X0, R5F100LEGFB#X0, R5F100LFGFB#X0 R5F100LGGFB#V0, R5F100LHGFB#V0, R5F100LJGFB#V0
				R5F100LGGFB#X0, R5F100LHGFB#X0, R5F100LJGFB#X0
		Not mounted	A	R5F101LCAFB#V0, R5F101LDAFB#V0, R5F101LEAFB#V0, R5F101LFAFB#V0, R5F101LGAFB#V0, R5F101LHAFB#V0, R5F101LJAFB#V0, R5F101LKAFB#V0, R5F101LCAFB#X0, R5F101LDAFB#X0, R5F101LEAFB#X0,
			D	R5F101LFAFB#X0, R5F101LGAFB#X0, R5F101LHAFB#X0, R5F101LJAFB#X0, R5F101LKAFB#X0, R5F101LLAFB#X0 R5F101LCDFB#V0, R5F101LDDFB#V0, R5F101LEDFB#V0, R5F101LFDFB#V0, R5F101LFDFB#V0, R5F101LJDFB#V0, R5F101LJDFB#V0, R5F101LLDFB#V0, R5F101LCDFB#X0,
				R5F101LFDFB#X0, R5F101LGDFB#X0, R5F101LHDFB#X0, R5F101LJDFB#X0, R5F101LKDFB#X0, R5F101LLDFB#X0
	64-pin plastic VFBGA (4 × 4 mm, 0.4 mm pitch)	Mounted	A	R5F100LCABG#U0, R5F100LDABG#U0, R5F100LEABG#U0, R5F100LFABG#U0, R5F100LGABG#U0, R5F100LHABG#U0, R5F100LJABG#U0 R5F100LCABG#W0, R5F100LDABG#W0, R5F100LEABG#W0,
	picity		G	R5F100LFABG#W0, R5F100LGABG#W0, R5F100LHABG#W0, R5F100LJABG#W0 R5F100LCGBG#U0, R5F100LDGBG#U0, R5F100LEGBG#U0, R5F100LFGBG#U0, R5F100LGGBG#U0, R5F100LHGBG#U0, R5F100LJGBG#U0
				R5F100LCGBG#W0, R5F100LDGBG#W0, R5F100LEGBG#W0, R5F100LFGBG#W0, R5F100LGGBG#W0, R5F100LHGBG#W0, R5F100LJGBG#W0
		Not mounted	A	R5F101LCABG#U0, R5F101LDABG#U0, R5F101LEABG#U0, R5F101LFABG#U0, R5F101LGABG#U0, R5F101LHABG#U0, R5F101LJABG#U0 R5F101LCABG#W0, R5F101LCABG#W0, R5F101LEABG#W0, R5F101LEABG#W0, R5F101LEABG#W0, R5F101LEABG#W0, R5F101LEABG#W0
				R5F101LFABG#W0, R5F101LGABG#W0, R5F101LHABG#W0, R5F101LJABG#W0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.



Table 1-1. List of Ordering Part Numbers

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Pin count	Package	Data flash	Fields of Application	Ordering Part Number
80 pins	80-pin plastic LQFP (14 × 14 mm, 0.65 mm pitch)	Mounted	А	R5F100MFAFA#V0, R5F100MGAFA#V0, R5F100MHAFA#V0, R5F100MJAFA#V0, R5F100MKAFA#V0, R5F100MLAFA#V0 R5F100MFAFA#X0, R5F100MGAFA#X0, R5F100MHAFA#X0, R5F100MJAFA#X0, R5F100MKAFA#X0, R5F100MLAFA#X0
			D	R5F100MFDFA#V0, R5F100MGDFA#V0, R5F100MHDFA#V0, R5F100MJDFA#V0, R5F100MKDFA#V0, R5F100MFDFA#X0, R5F100MFDFA#X0, R5F100MFDFA#X0, R5F100MJDFA#X0, R5F100MKDFA#X0, R5F100MLDFA#X0
			G	R5F100MFGFA#V0, R5F100MGGFA#V0, R5F100MHGFA#V0, R5F100MJGFA#V0 R5F100MFGFA#X0, R5F100MGGFA#X0, R5F100MJGFA#X0, R5F100MJGFA#X0
		Not mounted	A	R5F101MFAFA#V0, R5F101MGAFA#V0, R5F101MHAFA#V0, R5F101MJAFA#V0, R5F101MKAFA#V0, R5F101MLAFA#V0 R5F101MFAFA#X0, R5F101MGAFA#X0, R5F101MJAFA#X0, R5F101MKAFA#X0, R5F101MLAFA#X0
			D	R5F101MFDFA#V0, R5F101MGDFA#V0, R5F101MHDFA#V0, R5F101MJDFA#V0, R5F101MKDFA#V0, R5F101MLDFA#V0 R5F101MFDFA#X0, R5F101MGDFA#X0, R5F101MHDFA#X0, R5F101MJDFA#X0, R5F101MKDFA#X0, R5F101MJDFA#X0
	80-pin plastic LFQFP (12 × 12 mm, 0.5 mm pitch)	Mounted	A	R5F100MFAFB#V0, R5F100MGAFB#V0, R5F100MHAFB#V0, R5F100MJAFB#V0, R5F100MKAFB#V0, R5F100MLAFB#V0 R5F100MFAFB#X0, R5F100MGAFB#X0, R5F100MJAFB#X0, R5F100MKAFB#X0, R5F100MLAFB#X0
			D	R5F100MFDFB#V0, R5F100MGDFB#V0, R5F100MHDFB#V0, R5F100MJDFB#V0, R5F100MKDFB#V0, R5F100MLDFB#V0 R5F100MFDFB#X0, R5F100MGDFB#X0, R5F100MHDFB#X0, R5F100MJDFB#X0, R5F100MKDFB#X0, R5F100MLDFB#X0
			G	R5F100MFGFB#V0, R5F100MGGFB#V0, R5F100MHGFB#V0, R5F100MJGFB#V0 R5F100MFGFB#X0, R5F100MGGFB#X0, R5F100MJGFB#X0, R5F100MJGFB#X0
		Not mounted	A	R5F101MFAFB#V0, R5F101MGAFB#V0, R5F101MHAFB#V0, R5F101MJAFB#V0, R5F101MKAFB#V0, R5F101MFAFB#X0, R5F101MGAFB#X0, R5F101MHAFB#X0, R5F101MJAFB#X0, R5F101MKAFB#X0, R5F101MLAFB#X0
			D	R5F101MFDFB#V0, R5F101MGDFB#V0, R5F101MHDFB#V0, R5F101MJDFB#V0, R5F101MKDFB#V0, R5F101MLDFB#V0 R5F101MFDFB#X0, R5F101MGDFB#X0, R5F101MHDFB#X0, R5F101MJDFB#X0, R5F101MKDFB#X0, R5F101MLDFB#X0

Note For the fields of application, refer to Figure 1-1 Part Number, Memory Size, and Package of RL78/G13.



 The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see 6.9.3 Operation as multiple PWM output function in the RL78/G13 User's Manual).

(2/2)

							(2/2)	
Ite	m	80-	pin	100	-pin	128-pin		
		R5F100Mx	x R5F101Mx R5F100Px R5F101Px		R5F101Px	R5F100Sx	R5F101Sx	
Clock output/buzz	er output		2	1	2		2	
		• 2.44 kHz, 4.8	8 kHz, 9.76 kHz,	1.25 MHz, 2.5 M	Hz, 5 MHz, 10 M	ИHz		
		(Main system clock: fmain = 20 MHz operation)						
				.048 kHz, 4.096 k		16.384 kHz, 32.76	68 kHz	
0/40 1 "	A /D		CIOCK: ISUB = 32.70	68 kHz operation)		I		
8/10-bit resolution	A/D converter	17 channels		20 channels		26 channels		
Serial interface			, 128-pin product					
			•	2 channels/UAR				
			•	2 channels/UAR 2 channels/UAR		tina I IN-hus): 1 (	channel	
			•	2 channels/UAR		ang Ent baoj. T	onamo:	
	I <sup>2</sup> C bus	2 channels	·	2 channels		2 channels		
Multiplier and divid	der/multiply-	• 16 bits × 16 bi	ts = 32 bits (Uns	igned or signed)				
accumulator		• 32 bits ÷ 32 bits = 32 bits (Unsigned)						
		• 16 bits × 16 bits	ts + 32 bits = 32	bits (Unsigned or	signed)			
DMA controller		4 channels						
Vectored	Internal		37 37		37	41		
interrupt sources	External		13	1	3		13	
Key interrupt			8	1	8		8	
Reset		Reset by RES						
			by watchdog tim					
			by power-on-res by voltage detec					
				tion execution Note				
			by RAM parity e					
			by illegal-memor					
Power-on-reset cir	rcuit	Power-on-res	et: 1.51 V (TY	P.)				
		Power-down-	reset: 1.50 V (TY	P.)				
Voltage detector		Rising edge :		.06 V (14 stages)	)			
		• Falling edge : 1.63 V to 3.98 V (14 stages)						
On-chip debug fur	nction	Provided						
Power supply volta	age	$V_{DD} = 1.6 \text{ to } 5.5$	$V (T_A = -40 \text{ to } +8$	5°C)				
		$V_{DD} = 2.4 \text{ to } 5.5 \text{ V } (T_A = -40 \text{ to } +105^{\circ}\text{C})$						
Operating ambien	t temperature	$T_A = 40 \text{ to } +85^\circ$	C (A: Consumer	applications, D: Ir	ndustrial applicat	ions)		
		$T_A = 40 \text{ to } +105$	°C (G: Industrial	applications)				
		1						



Note The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.



Absolute Maximum Ratings (TA = 25°C) (2/2)

Parameter	Symbols		Conditions	Ratings	Unit
Output current, high	Іон1	Per pin	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	-40	mA
		Total of all pins -170 mA	P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145	-70	mA
			P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147	-100	mA
	<b>І</b> ОН2	Per pin	P20 to P27, P150 to P156	-0.5	mA
		Total of all pins		-2	mA
Output current, low	lo <sub>L1</sub>	Per pin	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	40	mA
		Total of all pins 170 mA	P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145	70	mA
			P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147	100	mA
	lo <sub>L2</sub>	Per pin	P20 to P27, P150 to P156	1	mA
		Total of all pins		5	mA
Operating ambient	TA	In normal operati	on mode	-40 to +85	°C
temperature		In flash memory	programming mode		
Storage temperature	Tstg			-65 to +150	°C

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 1.6 \text{ V} \le \text{EV}_{DD0} = \text{EV}_{DD1} \le \text{V}_{DD} \le 5.5 \text{ V}, \text{Vss} = \text{EV}_{SS0} = \text{EV}_{SS1} = 0 \text{ V}) (2/5)$ 

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output current, low <sup>Note 1</sup>	lo <sub>L1</sub>	Per pin for P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147				20.0 Note 2	mA
		Per pin for P60 to P63				15.0 Note 2	mA
		Total of P00 to P04, P07, P32 to	$4.0~V \leq EV_{DD0} \leq 5.5~V$			70.0	mA
		P37, P40 to P47, P102 to P106, P120,	$2.7~V \leq EV_{DD0} < 4.0~V$			15.0	mA
		P125 to P127, P130, P140 to P145	$1.8~V \leq EV_{DD0} < 2.7~V$	/ 9	9.0	mA	
		(When duty ≤ 70% Note 3)	$1.6 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V}$			4.5	mA
		Total of P05, P06, P10 to P17, P30,	$4.0~V \leq EV_{DD0} \leq 5.5~V$			80.0	mA
		P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97.	$2.7~V \leq EV_{DD0} < 4.0~V$			35.0	mA
		P100, P101, P110 to P117, P146,	$1.8~V \leq EV_{DD0} < 2.7~V$			20.0	mA
		P147 (When duty ≤ 70% Note 3)	$1.6~V \le EV_{DD0} < 1.8~V$			10.0	mA
		Total of all pins (When duty ≤ 70% Note 3)				150.0	mA
	lo <sub>L2</sub>	Per pin for P20 to P27, P150 to P156				0.4 Note 2	mA
		Total of all pins (When duty ≤ 70% Note 3)	$1.6~V \leq V_{DD} \leq 5.5~V$			5.0	mA

- **Notes 1**. Value of current at which the device operation is guaranteed even if the current flows from an output pin to the EVsso, EVss1 and Vss pin.
  - 2. However, do not exceed the total current value.
  - **3.** Specification under conditions where the duty factor  $\leq 70\%$ .

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins =  $(lol \times 0.7)/(n \times 0.01)$
- <Example> Where n = 80% and lol = 10.0 mA

Total output current of pins =  $(10.0 \times 0.7)/(80 \times 0.01) \approx 8.7$  mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Notes 1. Total current flowing into VDD, EVDDO, and EVDD1, including the input leakage current flowing when the level of the input pin is fixed to VDD, EVDDO, and EVDD1, or Vss, EVsso, and EVss1. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. When high-speed on-chip oscillator and subsystem clock are stopped.
  - 3. When high-speed system clock and subsystem clock are stopped.
  - **4.** When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - **5.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode:  $2.7 \text{ V} \le \text{V}_{DD} \le 5.5 \text{ V} @ 1 \text{ MHz}$  to 32 MHz

 $2.4~V \leq V_{DD} \leq 5.5~V @ 1~MHz$  to 16 MHz

LS (low-speed main) mode:  $1.8~V \le V_{DD} \le 5.5~V~@1~MHz$  to 8~MHz LV (low-voltage main) mode:  $1.6~V \le V_{DD} \le 5.5~V~@1~MHz$  to 4~MHz

- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - 4. Except subsystem clock operation, temperature condition of the TYP. value is TA = 25°C

- Notes 1. Total current flowing into VDD, EVDDD, and EVDD1, including the input leakage current flowing when the level of the input pin is fixed to VDD, EVDDD, and EVDD1, or Vss, EVSSD, and EVSS1. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  - 2. During HALT instruction execution by flash memory.
  - 3. When high-speed on-chip oscillator and subsystem clock are stopped.
  - **4.** When high-speed system clock and subsystem clock are stopped.
  - **5.** When high-speed on-chip oscillator and high-speed system clock are stopped. When RTCLPC = 1 and setting ultra-low current consumption (AMPHS1 = 1). The current flowing into the RTC is included. However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  - 6. Not including the current flowing into the RTC, 12-bit interval timer, and watchdog timer.
  - **7.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode:  $2.7 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz to } 32 \text{ MHz}$   $2.4 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz to } 16 \text{ MHz}$  LS (low-speed main) mode:  $1.8 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz to } 8 \text{ MHz}$  LV (low-voltage main) mode:  $1.6 \text{ V} \le \text{V}_{\text{DD}} \le 5.5 \text{ V} @ 1 \text{ MHz to } 4 \text{ MHz}$ 

- **8.** Regarding the value for current to operate the subsystem clock in STOP mode, refer to that in HALT mode.
- Remarks 1. fmx: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  - 2. fin: High-speed on-chip oscillator clock frequency
  - 3. fsub: Subsystem clock frequency (XT1 clock oscillation frequency)
  - **4.** Except subsystem clock operation and STOP mode, temperature condition of the TYP. value is  $T_A = 25^{\circ}C$

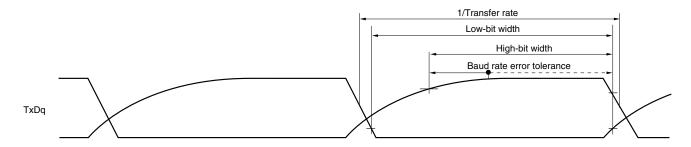
## (5) During communication at same potential (simplified I<sup>2</sup>C mode) (1/2)

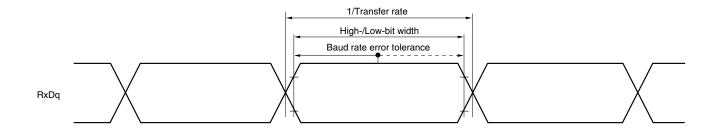
(Ta = -40 to +85°C, 1.6 V  $\leq$  EVDD0 = EVDD1  $\leq$  VDD  $\leq$  5.5 V, Vss = EVss0 = EVss1 = 0 V)

Parameter	Symbol	Conditions	` `	h-speed Mode	LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLr clock frequency	fscL	$2.7~V \leq EV_{DD0} \leq 5.5~V,$ $C_b = 50~pF,~R_b = 2.7~k\Omega$		1000 Note 1		400 Note 1		400 Note 1	kHz
		$1.8~V \leq EV_{DD0} \leq 5.5~V,$ $C_b = 100~pF,~R_b = 3~k\Omega$		400 Note 1		400 Note 1		400 Note 1	kHz
		1.8 V $\leq$ EV <sub>DD0</sub> $<$ 2.7 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ		300 Note 1		300 Note 1		300 Note 1	kHz
		$1.7 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$		250 Note 1		250 Note 1		250 Note 1	kHz
		1.6 V $\leq$ EV <sub>DD0</sub> $<$ 1.8 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 5 kΩ		_		250 Note 1		250 Note 1	kHz
Hold time when SCLr = "L"	tLOW	$2.7~V \leq EV_{DD0} \leq 5.5~V,$ $C_b = 50~pF,~R_b = 2.7~k\Omega$	475		1150		1150		ns
		$1.8 \text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 3 \text{ k}\Omega$	1150		1150		1150		ns
		$1.8 \text{ V} \le \text{EV}_{\text{DD0}} < 2.7 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	1550		1550		1550		ns
		$1.7 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	1850		1850		1850		ns
		$1.6 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	_		1850		1850		ns
Hold time when SCLr = "H"	tніgн	$2.7 \text{ V} \le \text{EV}_{\text{DD0}} \le 5.5 \text{ V},$ $C_b = 50 \text{ pF}, R_b = 2.7 \text{ k}\Omega$	475		1150		1150		ns
		1.8 V $\leq$ EV <sub>DD0</sub> $\leq$ 5.5 V, C <sub>b</sub> = 100 pF, R <sub>b</sub> = 3 kΩ	1150		1150		1150		ns
		$1.8 \text{ V} \le \text{EV}_{\text{DD0}} < 2.7 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	1550		1550		1550		ns
		$1.7 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	1850		1850		1850		ns
		$1.6 \text{ V} \le \text{EV}_{\text{DD0}} < 1.8 \text{ V},$ $C_b = 100 \text{ pF}, R_b = 5 \text{ k}\Omega$	_		1850		1850		ns

(Notes and Caution are listed on the next page, and Remarks are listed on the page after the next page.)

### UART mode bit width (during communication at different potential) (reference)





- $\begin{tabular}{ll} \begin{tabular}{ll} \bf R_b[\Omega]: Communication line (TxDq) pull-up resistance, \\ C_b[F]: Communication line (TxDq) load capacitance, V_b[V]: Communication line voltage \\ \end{tabular}$ 
  - 2. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
  - 3. fmck: Serial array unit operation clock frequency(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))
  - **4.** UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.

# (7) Communication at different potential (2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only) (1/2)

(Ta = -40 to +85°C, 2.7 V  $\leq$  EVDD0 = EVDD1  $\leq$  VDD  $\leq$  5.5 V, Vss = EVss0 = EVss1 = 0 V)

Parameter	Symbol		Conditions	HS (hig		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	tkcy1	tkcy1 ≥ 2/fclk	$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 20 \; pF, \; R_b = 1.4 \\ &k\Omega \end{aligned} $	200		1150		1150		ns
			$\begin{split} & 2.7 \; \text{V} \leq \text{EV}_{\text{DD0}} < 4.0 \; \text{V}, \\ & 2.3 \; \text{V} \leq \text{V}_{\text{b}} \leq 2.7 \; \text{V}, \\ & C_{\text{b}} = 20 \; \text{pF}, \; R_{\text{b}} = 2.7 \\ & \text{k}\Omega \end{split}$	300		1150		1150		ns
SCKp high-level width	tкнı	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 6$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	tксү1/2 — 50		tксу1/2 — 50		tксү1/2 — 50		ns
		·		tксу1/2 — 120		tксу1/2 — 120		tксу1/2 — 120		ns
SCKp low-level width	tĸL1	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 6$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	tксү1/2 — 7		t <sub>KCY1</sub> /2 – 50		t <sub>KCY1</sub> /2 – 50		ns
		$2.7 \text{ V} \leq \text{EV}_{DD}$ $2.3 \text{ V} \leq \text{V}_{b} \leq 3$ $C_{b} = 20 \text{ pF, F}$	2.7 V,	tксу <sub>1</sub> /2 – 10		tксү1/2 — 50		tксү1/2 — 50		ns
SIp setup time (to SCKp↑) Note 1	tsıĸı	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 4$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	58		479		479		ns
		$2.7 \text{ V} \leq \text{EV}_{DD}$ $2.3 \text{ V} \leq \text{V}_{b} \leq 2$ $C_{b} = 20 \text{ pF, F}$	2.7 V,	121		479		479		ns
SIp hold time (from SCKp↑) Note 1	tksi1	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 4$ $C_{b} = 20 \text{ pF, F}$	4.0 V,	10		10		10		ns
		$2.7 \text{ V} \leq \text{EV}_{DD}$ $2.3 \text{ V} \leq \text{V}_{b} \leq 2$ $C_{b} = 20 \text{ pF}, \text{ F}$	2.7 V,	10		10		10		ns
Delay time from SCKp↓ to SOp output Note 1	tkso1	$4.0 \text{ V} \leq \text{EV}_{DD}$ $2.7 \text{ V} \leq \text{V}_{b} \leq 4.0 \text{ C}$ $C_{b} = 20 \text{ pF, F}$	o ≤ 5.5 V, 4.0 V,		60		60		60	ns
		$2.7 \text{ V} \le \text{EV}_{DD}$ $2.3 \text{ V} \le \text{V}_{b} \le 2$ $C_{b} = 20 \text{ pF, F}$	o < 4.0 V, 2.7 V,		130		130		130	ns

(Notes, Caution, and Remarks are listed on the next page.)

## (10) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified $I^2C$ mode) (1/2)

(Ta = -40 to +85°C, 1.8 V  $\leq$  EVDD0 = EVDD1  $\leq$  VDD  $\leq$  5.5 V, Vss = EVss0 = EVss1 = 0 V)

Parameter	Symbol	Conditions	, -	h-speed Mode	,	v-speed Mode	LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLr clock frequency	fscL	$\begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 50 \; pF, \; R_b = 2.7 \; k\Omega \end{aligned}$		1000 Note 1		300 Note 1		300 Note 1	kHz
		$\label{eq:substitute} \begin{split} &2.7 \; V \leq EV_{DD0} < 4.0 \; V, \\ &2.3 \; V \leq V_b \leq 2.7 \; V, \\ &C_b = 50 \; pF, \; R_b = 2.7 \; k\Omega \end{split}$		1000 Note 1		300 Note 1		300 Note 1	kHz
		$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 100 \; pF, \; R_b = 2.8 \; k\Omega \end{aligned} $		400 Note 1		300 Note 1		300 Note 1	kHz
		$\label{eq:section} \begin{split} 2.7 \ V & \leq EV_{DD0} < 4.0 \ V, \\ 2.3 \ V & \leq V_b \leq 2.7 \ V, \\ C_b & = 100 \ pF, \ R_b = 2.7 \ k\Omega \end{split}$		400 Note 1		300 Note 1		300 ote 1	kHz
		$\begin{split} &1.8~V \leq EV_{DD0} < 3.3~V,\\ &1.6~V \leq V_b \leq 2.0~V^{\text{Note 2}},\\ &C_b = 100~pF,~R_b = 5.5~k\Omega \end{split}$		300 Note 1		300 Note 1		300 Note 1	kHz
Hold time when SCLr = "L"	tLOW	$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 50 \; pF, \; R_b = 2.7 \; k\Omega \end{aligned} $	475		1550		1550		ns
		eq:second-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state-state	475		1550		1550		ns
		$ \begin{aligned} &4.0 \; V \leq EV_{DD0} \leq 5.5 \; V, \\ &2.7 \; V \leq V_b \leq 4.0 \; V, \\ &C_b = 100 \; pF, \; R_b = 2.8 \; k\Omega \end{aligned} $	1150		1550		1550		ns
		$\label{eq:section} \begin{split} 2.7 \ V & \leq EV_{DD0} < 4.0 \ V, \\ 2.3 \ V & \leq V_b \leq 2.7 \ V, \\ C_b & = 100 \ pF, \ R_b = 2.7 \ k\Omega \end{split}$	1150		1550		1550		ns
		$\begin{split} &1.8~V \leq EV_{DD0} < 3.3~V,\\ &1.6~V \leq V_b \leq 2.0~V^{\text{Note 2}},\\ &C_b = 100~pF,~R_b = 5.5~k\Omega \end{split}$	1550		1550		1550		ns
Hold time when SCLr = "H"	tнівн	$ 4.0 \ V \le EV_{DD0} \le 5.5 \ V, $ $ 2.7 \ V \le V_b \le 4.0 \ V, $ $ C_b = 50 \ pF, \ R_b = 2.7 \ k\Omega $	245		610		610		ns
		$ 2.7 \text{ V} \leq \text{EV}_{\text{DDO}} < 4.0 \text{ V}, \\ 2.3 \text{ V} \leq \text{V}_{\text{b}} \leq 2.7 \text{ V}, \\ C_{\text{b}} = 50 \text{ pF}, \text{ R}_{\text{b}} = 2.7 \text{ k}\Omega $	200		610		610		ns
		$ \begin{aligned} & 4.0 \text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5 \text{ V}, \\ & 2.7 \text{ V} \leq \text{V}_{\text{b}} \leq 4.0 \text{ V}, \\ & C_{\text{b}} = 100 \text{ pF}, \text{ R}_{\text{b}} = 2.8 \text{ k}\Omega \end{aligned} $	675		610		610		ns
		$ 2.7 \text{ V} \leq \text{EV}_{\text{DDO}} < 4.0 \text{ V}, \\ 2.3 \text{ V} \leq \text{V}_{\text{b}} \leq 2.7 \text{ V}, \\ C_{\text{b}} = 100 \text{ pF}, \text{ R}_{\text{b}} = 2.7 \text{ k}\Omega $	600		610		610		ns
		$\begin{split} &1.8~V \leq EV_{DDO} < 3.3~V,\\ &1.6~V \leq V_b \leq 2.0~V^{\text{Note 2}},\\ &C_b = 100~pF,~R_b = 5.5~k\Omega \end{split}$	610		610		610		ns

**Notes 1.** The first clock pulse is generated after this period when the start/restart condition is detected.

<R>

2. The maximum value (MAX.) of thd:DAT is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (IoH1, IoL1, VOH1, VOL1) must satisfy the values in the redirect destination.

**Remark** The maximum value of Cb (communication line capacitance) and the value of Rb (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode:  $C_b = 400 \text{ pF}, R_b = 2.7 \text{ k}\Omega$ 



(3) When reference voltage (+) = VDD (ADREFP1 = 0, ADREFP0 = 0), reference voltage (-) = Vss (ADREFM = 0), target pin : ANI0 to ANI14, ANI16 to ANI26, internal reference voltage, and temperature sensor output voltage

 $(T_A = -40 \text{ to } +85^{\circ}\text{C}, 1.6 \text{ V} \le \text{EV}_{\text{DD}0} = \text{EV}_{\text{DD}1} \le \text{V}_{\text{DD}} \le 5.5 \text{ V}, \text{V}_{\text{SS}} = \text{EV}_{\text{SS}0} = \text{EV}_{\text{SS}1} = 0 \text{ V}, \text{Reference voltage (+)} = \text{V}_{\text{DD}}, \text{Reference voltage (-)} = \text{V}_{\text{SS}})$ 

Parameter	Symbol	Conditio	MIN.	TYP.	MAX.	Unit	
Resolution	RES			8		10	bit
Overall error <sup>Note 1</sup>	AINL	10-bit resolution	$1.8~V \leq V_{DD} \leq 5.5~V$		1.2	±7.0	LSB
			$1.6~V \leq V_{DD} \leq 5.5~V$ Note 3		1.2	±10.5	LSB
Conversion time	tconv	10-bit resolution	$3.6~V \leq V_{DD} \leq 5.5~V$	2.125		39	μS
		Target pin: ANI0 to ANI14, ANI16 to ANI26	$2.7~V \leq V_{DD} \leq 5.5~V$	3.1875		39	μS
			$1.8~V \leq V_{DD} \leq 5.5~V$	17		39	μS
			$1.6~V \leq V_{DD} \leq 5.5~V$	57		95	μS
Conversion time	tconv	10-bit resolution	$3.6~V \leq V_{DD} \leq 5.5~V$	2.375		39	μS
		Target pin: Internal	$2.7~V \leq V_{DD} \leq 5.5~V$	3.5625		39	μS
		reference voltage, and temperature sensor output voltage (HS (high-speed main) mode)	$2.4~V \leq V \text{DD} \leq 5.5~V$	17		39	μS
Zero-scale error <sup>Notes 1, 2</sup>	Ezs	10-bit resolution	$1.8~V \leq V_{DD} \leq 5.5~V$			±0.60	%FSR
			$\begin{array}{c} \text{1.6 V} \leq \text{VDD} \leq 5.5 \text{ V} \\ \text{Note 3} \end{array}$			±0.85	%FSR
Full-scale error <sup>Notes 1, 2</sup>	Ers	10-bit resolution	$1.8~V \leq V_{DD} \leq 5.5~V$			±0.60	%FSR
			$\begin{array}{ c c c }\hline 1.6 \ V \leq V_{DD} \leq 5.5 \ V\\ & \text{Note 3} \end{array}$			±0.85	%FSR
Integral linearity error <sup>Note 1</sup>	ILE	10-bit resolution	$1.8~V \leq V_{DD} \leq 5.5~V$			±4.0	LSB
			$1.6~V \leq V_{DD} \leq 5.5~V$ Note 3			±6.5	LSB
Differential linearity error Note 1	DLE	10-bit resolution	$1.8~V \leq V_{DD} \leq 5.5~V$			±2.0	LSB
			$1.6~\text{V} \leq \text{VDD} \leq 5.5~\text{V}$ Note 3			±2.5	LSB
Analog input voltage	Vain	ANI0 to ANI14	•	0		V <sub>DD</sub>	٧
		ANI16 to ANI26		0		EV <sub>DD0</sub>	٧
		Internal reference voltage (2.4 V ≤ VDD ≤ 5.5 V, HS (high-speed main) mode)		V <sub>BGR</sub> Note 4			V
		Temperature sensor output (2.4 V ≤ VDD ≤ 5.5 V, HS (hi	-		VTMPS25 Note 4	1	V

Notes 1. Excludes quantization error (±1/2 LSB).

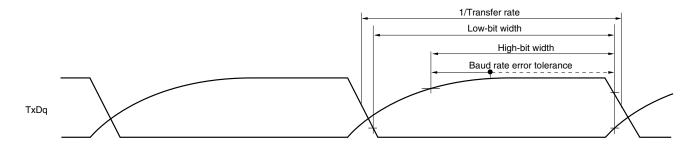
- 2. This value is indicated as a ratio (%FSR) to the full-scale value.
- 3. When the conversion time is set to 57  $\mu$ s (min.) and 95  $\mu$ s (max.).
- 4. Refer to 2.6.2 Temperature sensor/internal reference voltage characteristics.

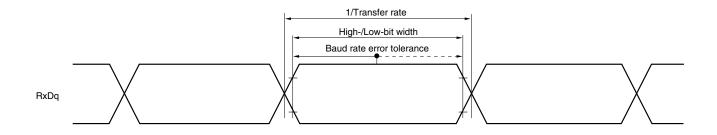
# (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products (Ta = -40 to $+105^{\circ}$ C, 2.4 V $\leq$ EV<sub>DD0</sub> = EV<sub>DD1</sub> $\leq$ V<sub>DD</sub> $\leq$ 5.5 V, Vss = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V) (2/2)

Parameter	Symbol			Conditions		MIN.	TYP.	MAX.	Unit
Supply	I <sub>DD2</sub>	HALT	HS (high-	fih = 32 MHz Note 4	V <sub>DD</sub> = 5.0 V		0.62	3.40	mA
current Note 1	Note 2	mode	speed main) mode Note 7		V <sub>DD</sub> = 3.0 V		0.62	3.40	mA
			mode	f <sub>IH</sub> = 24 MHz <sup>Note 4</sup>	V <sub>DD</sub> = 5.0 V		0.50	2.70	mA
					V <sub>DD</sub> = 3.0 V		0.50	2.70	mA
				fin = 16 MHz Note 4	V <sub>DD</sub> = 5.0 V		0.44	1.90	mA
					V <sub>DD</sub> = 3.0 V		0.44	1.90	mA
			HS (high- speed main) mode Note 7	$f_{MX} = 20 \text{ MHz}^{\text{Note 3}},$	Square wave input		0.31	2.10	mA
				V <sub>DD</sub> = 5.0 V	Resonator connection		0.48	2.20	mA
				$f_{MX} = 20 \text{ MHz}^{\text{Note 3}},$	Square wave input		0.31	2.10	mA
				V <sub>DD</sub> = 3.0 V	Resonator connection		0.48	2.20	mA
				$f_{MX} = 10 \text{ MHz}^{Note 3},$	Square wave input		0.21	1.10	mA
				V <sub>DD</sub> = 5.0 V	Resonator connection		0.28	1.20	mA
				$f_{MX} = 10 \text{ MHz}^{Note 3},$	Square wave input		0.21	1.10	mA
				V <sub>DD</sub> = 3.0 V	Resonator connection		0.28	1.20	mA
			Subsystem clock operation	fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.28	0.61	μΑ
				T <sub>A</sub> = -40°C	Resonator connection		0.47	0.80	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.34	0.61	μΑ
				T <sub>A</sub> = +25°C	Resonator connection		0.53	0.80	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.41	2.30	μΑ
				T <sub>A</sub> = +50°C	Resonator connection		0.60	2.49	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		0.64	4.03	μΑ
				T <sub>A</sub> = +70°C	Resonator connection		0.83	4.22	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		1.09	8.04	μΑ
				T <sub>A</sub> = +85°C	Resonator connection		1.28	8.23	μΑ
				fsub = 32.768 kHz <sup>Note 5</sup>	Square wave input		5.50	41.00	μΑ
				T <sub>A</sub> = +105°C	Resonator connection		5.50	41.00	μΑ
	IDD3 <sup>Note 6</sup>	STOP mode <sup>Note 8</sup>	$T_A = -40$ °C				0.19	0.52	μΑ
			$T_A = +25^{\circ}C$ $T_A = +50^{\circ}C$				0.25	0.52	μΑ
							0.32	2.21	μΑ
			T <sub>A</sub> = +70°C	T <sub>A</sub> = +70°C			0.55	3.94	μΑ
			T <sub>A</sub> = +85°C				1.00	7.95	μΑ
			T <sub>A</sub> = +105°C				5.00	40.00	μΑ

(Notes and Remarks are listed on the next page.)

#### UART mode bit width (during communication at different potential) (reference)





- $\begin{tabular}{ll} \textbf{Remarks 1.} & R_b[\Omega]: Communication line (TxDq) pull-up resistance, \\ & C_b[F]: Communication line (TxDq) load capacitance, V_b[V]: Communication line voltage \\ \end{tabular}$ 
  - **2.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)
  - 3. fmck: Serial array unit operation clock frequency(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))
  - **4.** UART2 cannot communicate at different potential when bit 1 (PIOR1) of peripheral I/O redirection register (PIOR) is 1.

Revision History
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# RL78/G13 Data Sheet

			Description		
Rev.	Date	Page	Summary		
1.00	Feb 29, 2012	-	First Edition issued		
2.00	Oct 12, 2012	7	Figure 1-1. Part Number, Memory Size, and Package of RL78/G13: Pin count corrected.		
		25	1.4 Pin Identification: Description of pins INTP0 to INTP11 corrected.		
		40, 42, 44	1.6 Outline of Functions: Descriptions of Subsystem clock, Low-speed on-chip oscillator, and General-purpose register corrected.		
		41, 43, 45	1.6 Outline of Functions: Lists of Descriptions changed.		
		59, 63, 67	Descriptions of Note 8 in a table corrected.		
		68	(4) Common to RL78/G13 all products: Descriptions of Notes corrected.		
		69	2.4 AC Characteristics: Symbol of external system clock frequency corrected.		
		96 to 98	2.6.1 A/D converter characteristics: Notes of overall error corrected.		
		100	2.6.2 Temperature sensor characteristics: Parameter name corrected.		
		104	2.8 Flash Memory Programming Characteristics: Incorrect descriptions corrected.		
		116	3.10 52-pin products: Package drawings of 52-pin products corrected.		
		120	3.12 80-pin products: Package drawings of 80-pin products corrected.		
3.00	Aug 02, 2013	1	Modification of 1.1 Features		
		3	Modification of 1.2 List of Part Numbers		
		4 to 15	Modification of Table 1-1. List of Ordering Part Numbers, note, and caution		
		16 to 32	Modification of package type in 1.3.1 to 1.3.14		
		33	Modification of description in 1.4 Pin Identification		
		48, 50, 52	Modification of caution, table, and note in 1.6 Outline of Functions		
		55	Modification of description in table of Absolute Maximum Ratings (T <sub>A</sub> = 25°C)		
		57	Modification of table, note, caution, and remark in 2.2.1 X1, XT1 oscillator characteristics		
		57	Modification of table in 2.2.2 On-chip oscillator characteristics		
		58	Modification of note 3 of table (1/5) in 2.3.1 Pin characteristics		
		59	Modification of note 3 of table (2/5) in 2.3.1 Pin characteristics		
		63			
		64	Modification of table in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products		
			Modification of notes 1 and 4 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products		
		65	Modification of table in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products		
		66	Modification of notes 1, 5, and 6 in (1) Flash ROM: 16 to 64 KB of 20- to 64-pin products		
		68	Modification of notes 1 and 4 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products		
		70	Modification of notes 1, 5, and 6 in (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products		
		72	Modification of notes 1 and 4 in (3) Flash ROM: 384 to 512 KB of 44- to 100-pin products		
		74	Modification of notes 1, 5, and 6 in (3) Flash ROM: 384 to 512 KB of 44- to 100-pin products		
		75	Modification of (4) Peripheral Functions (Common to all products)		
		77	Modification of table in 2.4 AC Characteristics		
		78, 79	Addition of Minimum Instruction Execution Time during Main System Clock Operation		
		80	Modification of figures of AC Timing Test Points and External System Clock Timing		

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